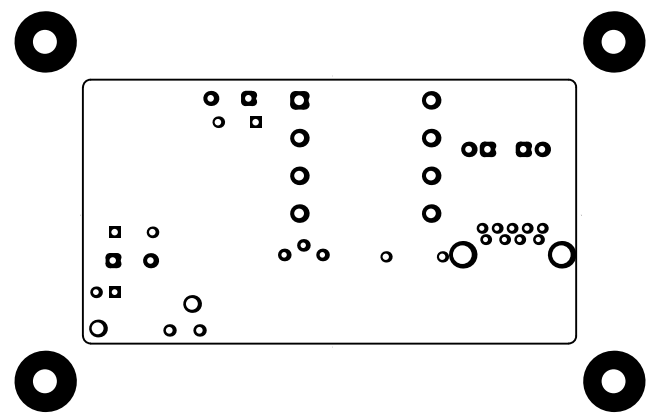
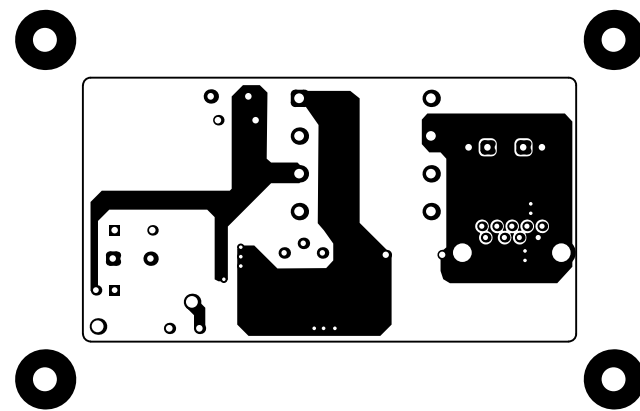


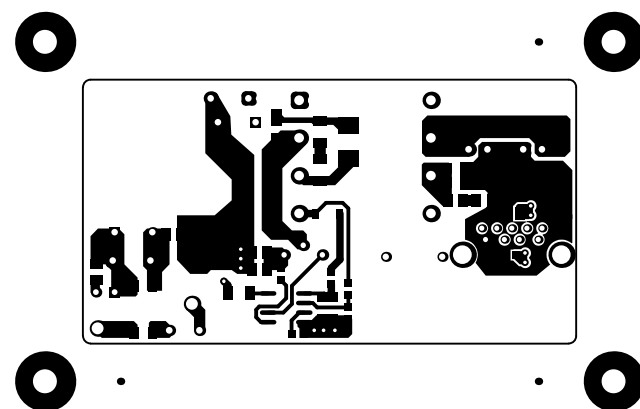
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9135	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 26/11/2013 11:20:36	TEXAS INSTRUMENTS	



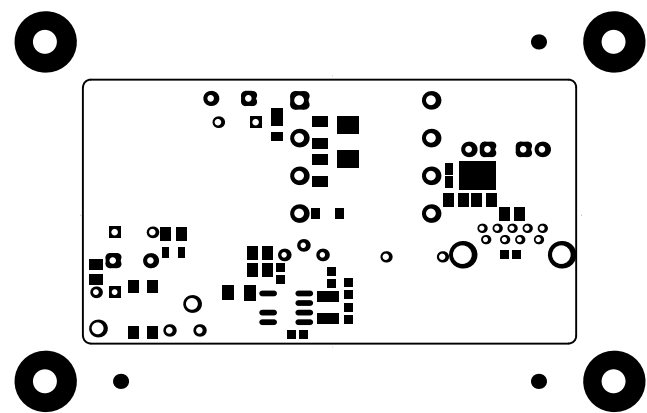
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LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 26/11/2013 11:20:36	TEXAS INSTRUMENTS	



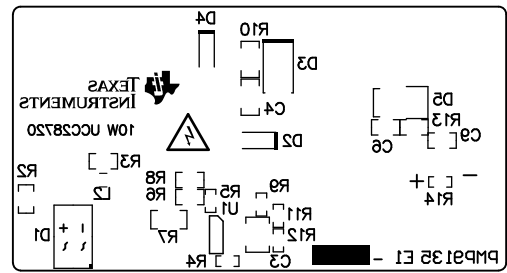
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9135	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 26/11/2013 11:20:37	TEXAS INSTRUMENTS	



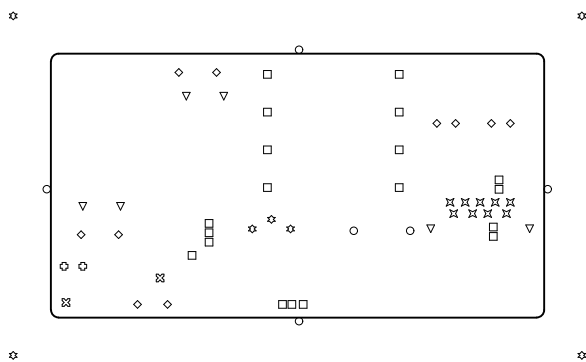
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9135	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 26/11/2013 11:20:38	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9135	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 26/11/2013 11:20:38	TEXAS INSTRUMENTS	



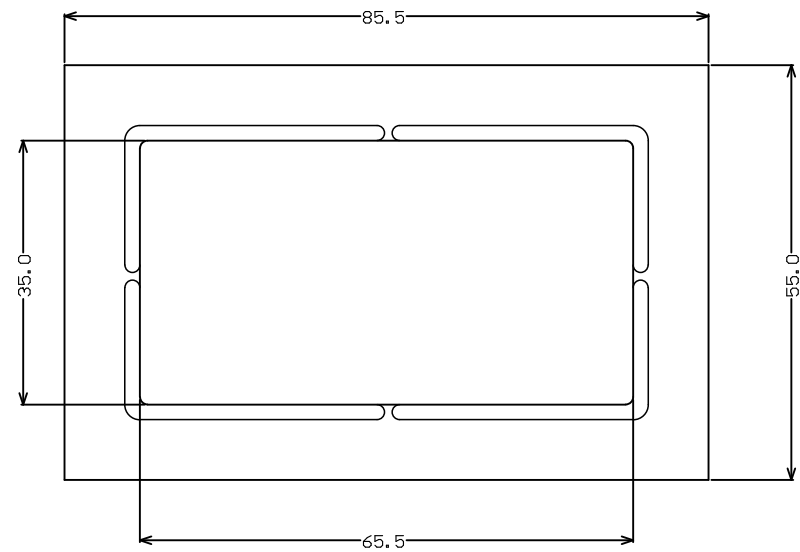
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9135	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 26/11/2013 11:20:39	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
○	4	0.5mm (19.685mil)	NPTH	Round
□	11	0.5mm (19.685mil)	PTH	Round
⊠	9	0.7mm (27.559mil)	PTH	Round
☆	3	0.75mm (29.528mil)	PTH	Round
⊙	2	0.787mm (31mil)	PTH	Round
○	2	0.85mm (33.465mil)	PTH	Round
▽	4	0.889mm (35mil)	PTH	Round
◇	10	0.9mm (35.433mil)	PTH	Round
□	8	1.3mm (51.181mil)	PTH	Round
⊠	2	1.6mm (63mil)	PTH	Round
▽	2	2.5mm (98.425mil)	PTH	Round
☆	4	3.2mm (125.984mil)	PTH	Round
	<b>61 Total</b>			

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9135	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 26/11/2013 11:20:39	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9135	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 26/11/2013 11:20:40	TEXAS INSTRUMENTS	



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